



VDRM

T(AV)

Iтѕм dV/dt*

dl/dt

KEY PARAMETERS

5200V

3990A

53300A

2000V/µs

1000A/µs

* Higher dV/dt selections are available on request



Replaces DS5940-5

Phase Control Thyristor

DS5940-6 March 2022 (LN41635	DS5940-6	March 2022	(LN41635)
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FEATURES

- Double Side Cooling
- High Surge Capability

APPLICATIONS

- Crowbar
- High Power Drives
- High Voltage Power Supplies
- Static Switches

VOLTAGE RATINGS

Part and Ordering Number	Repetitive Peak Voltages VDRM and VRRM (V)	Conditions
DCR3990A52* DCR3990A50 DCR3990A45	5200 5000 4500	$T_{vj} = -40^{\circ}C$ to 125°C, IDRM = IRRM = 300mA, VDRM, VRRM t _P = 10ms VDSM & VRSM = VDRM & VRRM + 100V respectively

Lower voltage grades available.

*5000V @ -40°C, 5200V @ 0°C

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DCR3990A52

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

Outline type code: A (See Package Details for further information)

Fig. 1 Package outline

CURRENT RATINGS

T_{case} = 60°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Si	de Cooled			
Ιτ(Αν)	Mean on-state current	Half wave resistive load	3990	А
It(rms)	RMS value	-	6270	А
Іт	Continuous (direct) on-state current	-	5640	А

SURGE RATINGS

Symbol	Parameter	Parameter Test Conditions		Units
Ітѕм	Surge (non-repetitive) on-state current	10ms half sine, Tcase = 125°C	53.3	kA
l²t	I ² t for fusing	VR = 0	14.2	MA ² s

THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions			Max.	Units
		Double side cooled	DC	-	6.0	°C/kW
Rth(j-c)	Rth(j-c) Thermal resistance - junction to case		Anode DC	-	10.4	°C/kW
		Single side cooled	Cathode DC	-	14.9	°C/kW
Back	Rth(c-h) Thermal resistance - case to heatsink	Clamping force 83kN	Double side	-	1.0	°C/kW
rtn(c-n)		(with mounting compound)	Single side	-	2.0	°C/kW
Tvj	Virtual junction temperature	Blocking Vdrm / Vrrm		-	125	°C
Tstg	Storage temperature range			-55	125	°C
Fm	Clamping force			74	91	kN

DYNAMIC CHARACTERISTICS

Symbol	Parameter	Test Conditior	IS	Тур.	Max.	Units
1	Deals reverse and aff state average	At VRRM/VDRM, Tcase = 125°C		-	300	mA
Irrm/Idrm	Peak reverse and off-state current	At 50% VRRM/VDRM, Tcase = 7	125°C	20	-	mA
Symbol	Parameter	Test Condition	IS	Min.	Max.	Units
Vтм	Instantaneous forward voltage	At 4000A peak, Tj = 125°C		1.45	1.65	V
dV/dt	Max. linear rate of rise of off-state voltage	То 67% Vdrm, Tj = 125°С, g	ate open	-	2000	V/µs
dl/dt	Rate of rise of on-state current	From 67% VDRM to 2x IT(AV) Gate source 30V, 10Ω	Repetitive 50Hz	-	400	A/µs
avat		tr < 0.5µs, Tj = 125°C	Non-repetitive	-	1000	A/µs
Veren	Threshold voltage - Low level	500A to 3600A at T _{case} = 125°C		-	0.85	V
V τ(το)	Threshold voltage - High level	3600A to 9000A at Tcase = 125°C		-	1.03	V
-	On-state slope resistance - Low level	500A to 3600A at Tcase = 125°C		-	0.21	mΩ
ľτ	On-state slope resistance - High level	3600A to 9000A at Tcase = 125°C		-	0.16	mΩ
tgd	Delay time	$V_D = 67\% V_{DRM}$, gate source 30V, 10 Ω tr = 0.5µs, Tj = 25°C		-	3	μs
tq	Turn-off time	$T_j = 125^{\circ}C$, $V_R = 200V$, $dI/dt = 1A/\mu s$ $dV_{DR}/dt = 20V/\mu s$ linear		-	750	μs
Qs	Stored charge	I⊤ = 1500A, Tj = 125°C, dl/dt = 1A/µs,		3870	8340	μC
Irr	Reverse recovery current	V _R ~ 2100V, Cs = 1μF, Rs = 63Ω		51	83	А
IL.	Latching current	Tj = 25°C, VD = 5V		-	3	А
Ін	Holding current	Тј = 25°С, Rg-к = ∞, Iтм = 50	0A, I⊤ = 5A	-	300	mA

GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
Vgт	Gate trigger voltage	Vdrm = 5V, Tcase = 25°C	1.5	V
Vgd	Gate non-trigger voltage	At 50% Vdrm, Tcase = 125°C	0.4	V
Іст	Gate trigger current	Vdrм = 5V, Tcase = 25°С	400	mA
Igd	Gate non-trigger current	At 50% Vdrм, Tcase = 125°С	10	mA

CURVES

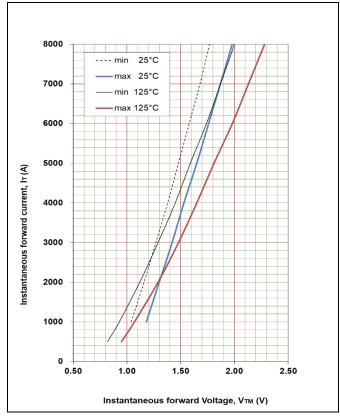


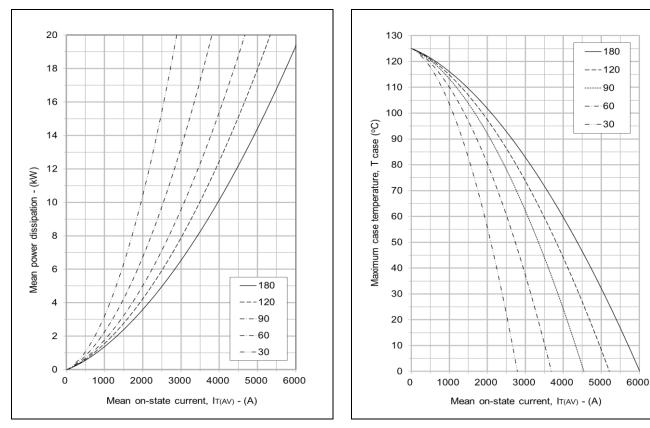
Fig. 2 Maximum & minimum on-state characteristics

VTM EQUATION

 $V_{TM} = A + B.ln(I_T) + C.I_T + D.\sqrt{I_T}$

Where A = 0.061663 B = 0.116682 C = 0.000119 D = 0.002396 These values are valid for $T_j = 125^{\circ}C$ for IT 500A to 9000A

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@2 ion

Fig. 3 On-state power dissipation - sine wave

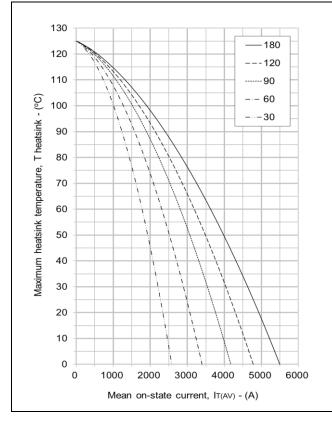


Fig. 5 Maximum permissible heatsink temperature, double side cooled - sine wave

Fig. 4 Maximum permissible case temperature, double side cooled - sine wave

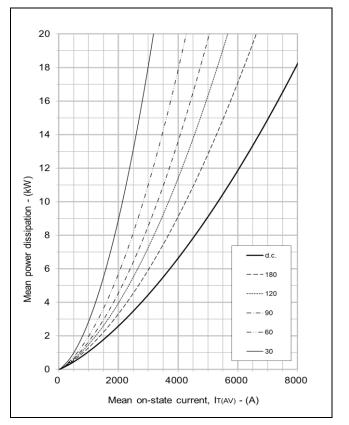


Fig. 6 On-state power dissipation - rectangular wave

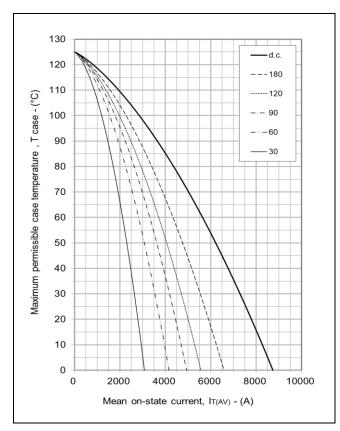
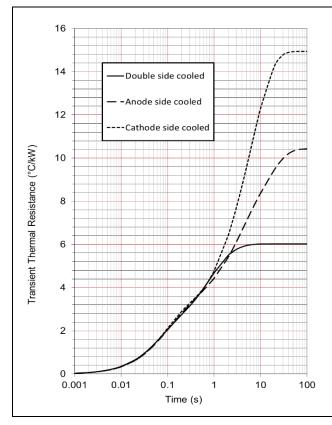


Fig. 7 Maximum permissible case temperature, double side cooled - rectangular wave



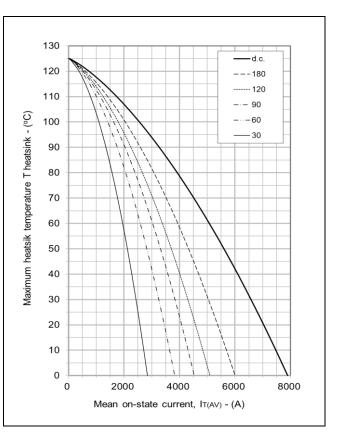


Fig. 8 Maximum permissible heatsink temperature, double side cooled - rectangular wave

		1	2	3	4
Double side	Ri(°C/kW)	3.015	1.049	0.984	0.984
cooled	Ti(s)	0.704	1.905	0.059	0.059
Anode side	Ri(°C/kW)	3.156	4.093	1.557	1.624
cooled	Ti(s)	2.690	13.792	0.059	0.206
Cathode side	Ri(°C/kW)	7.077	3.483	1.746	2.634
cooled	Ti(s)	6.649	8.436	1.762	0.081

$$Z_{th} = \sum_{i=1}^{i=4} R_i \cdot \left(1 - \exp\left(-\frac{T}{T_i}\right)\right)$$

 $\Delta R_{th(j-c)}$ Conduction

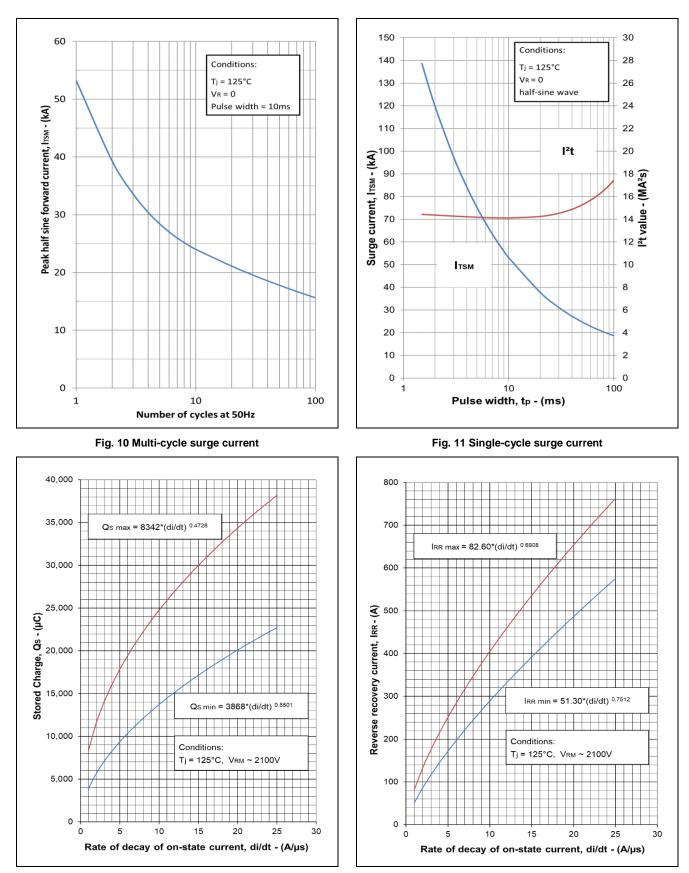
Tables show the increments of thermal resistance R $_{\text{frij-ej}}$ when the device operates at conduction angles other than d.c.

D	ouble side cooling Anode Side Cooling			Cath	ode Side	d Cooling					
	ΔZ_{th}	(z)		$\Delta Z_{th}(z)$		$\Delta Z_{th}(z)$				ΔZ	_{th} (z)
θ°	sine.	rect.	θ°	sine.	rect.	I I	θ°	sine.	rect.		
180	0.44	0.31	180	0.42	0.30	Ιſ	180	0.42	0.30		
120	0.49	0.43	120	0.47	0.41	1 [120	0.47	0.41		
90	0.55	0.49	90	0.52	0.46	Ιſ	90	0.52	0.46		
60	0.60	0.55	60	0.57	0.52	Í	60	0.57	0.52		
30	0.64	0.61	30	0.61	0.58		30	0.60	0.58		
15	0.66	0.64	15	0.62	0.61	ΙC	15	0.62	0.60		

Fig.9 Maximum (limit) transient thermal impedance - junction to case (degC/kW)

@2 ion

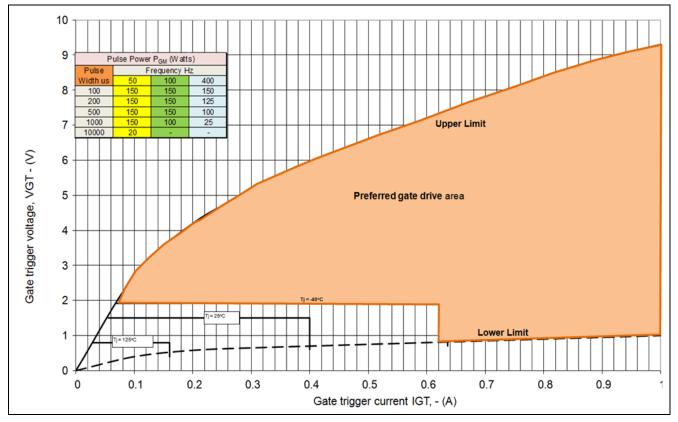
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Fig. 12 Stored charge

Fig. 13 Reverse recovery current



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Fig.14 Gate characteristics

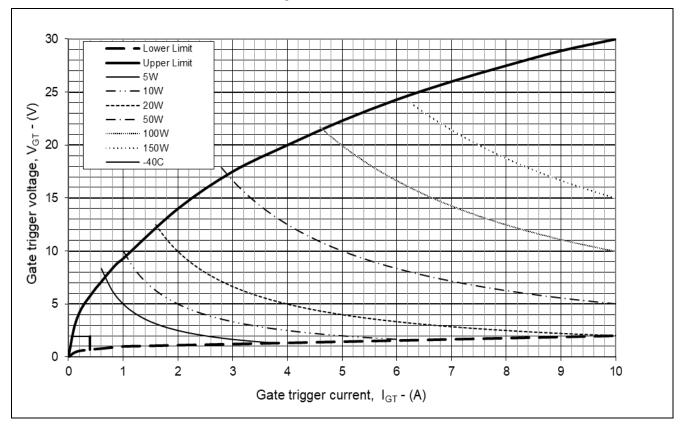


Fig. 15 Gate characteristics

PACKAGE DETAILS

For further package information, please contact Customer services.

All dimensions in mm, unless stated otherwise.

DO NOT SCALE

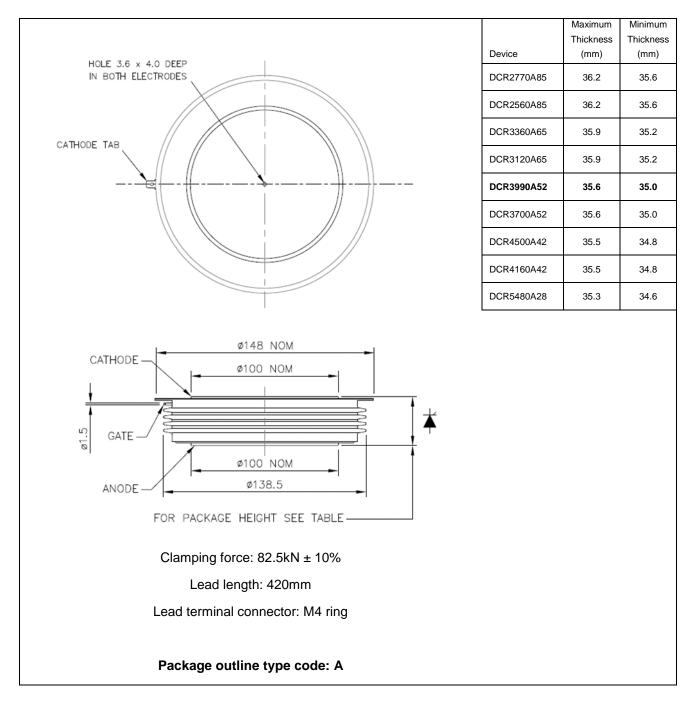


Fig. 16 Package outline

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